

FIG. 1. All processes, materials, etc. described *supra* for FIG. 1 apply to FIG. 23 except for differences attributable to the geometrical difference between the volume of material **19** of FIG. 23 and the coat of material **18** of FIG. 1. The volume of material **19** is said to volumetrically surround the conductive bodies **44**. As seen in FIGS. 23-28, the volume of material **19** is continuously distributed between the two first conductive bodies **14** shown in FIGS. 23-28, and the volume of material **19** fills a space between the two first conductive bodies **14** shown in FIGS. 23-28.